



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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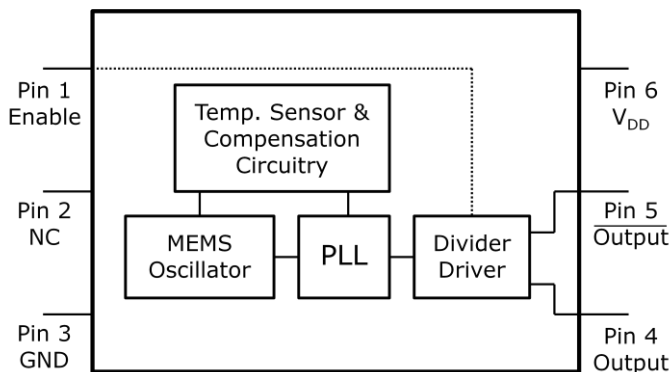


General Description

The DSC8103 & DSC8123 series of high performance field-programmable oscillators utilizes a proven silicon MEMS technology to provide excellent jitter and stability over a wide range of supply voltages and temperatures. Using the TIMEFLASH programmer, the end user can easily program the oscillators' frequency in the field for immediate testing or use in advance prototype development or production.

DSC8103 has a standby feature allowing it to completely power-down when EN pin is pulled low; whereas for DSC8123, only the outputs are disabled when EN is low. Both oscillators are available in industry standard packages, including the small 3.2x2.5 mm², and are "drop-in" replacement for standard 6-pin LVDS quartz oscillators.

Block Diagram



Output Enable Modes

EN Pin	DSC8103	DSC8123
High	Outputs Active	Outputs Active
NC	Outputs Active	Outputs Active
Low	Standby	Outputs Disabled

Features

- **Low RMS Phase Jitter: <1 ps (typ)**
- **High Stability: ± 10 , ± 25 , ± 50 ppm**
- **Wide Temperature Range**
 - Industrial: -40° to 85° C
 - Ext. commercial: -20° to 70° C
- **High Supply Noise Rejection: -50 dBc**
- **Short Lead Time: 2 Weeks**
- **Wide Freq. Range: 10 to 460 MHz**
- **Small Industry Standard Footprints**
 - 2.5x2.0, 3.2x2.5, 5.0x3.2, & 7.0x5.0 mm
- **Excellent Shock & Vibration Immunity**
 - Qualified to MIL-STD-883
- **High Reliability**
 - 20x better MTF than quartz oscillators
- **Low Current Consumption**
- **Supply Range of 2.25 to 3.6 V**
- **Standby & Output Enable Function**
- **Lead Free & RoHS Compliant**
- **LVPECL & HCSL Versions Available**

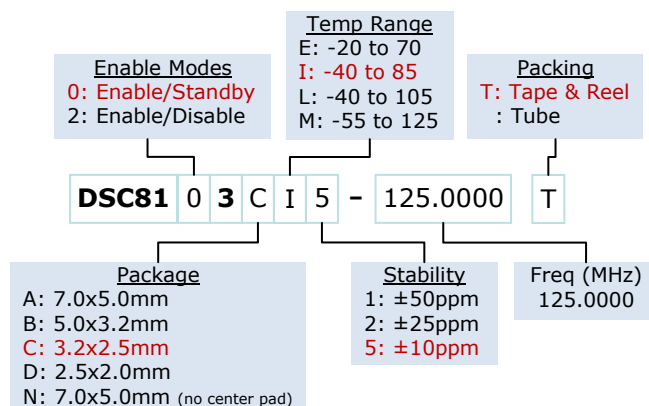
Applications

- **Storage Area Networks**
 - SATA, SAS, Fibre Channel
- **Passive Optical Networks**
 - EPON, 10G-EPON, GPON, 10G-PON
- **Ethernet**
 - 1G, 10GBASE-T/KR/LR/SR, and FCoE
- **HD/SD/SDI Video & Surveillance**
- **PCI Express: Gen 1 & Gen 2**
- **DisplayPort**

Absolute Maximum Ratings

Item	Min	Max	Unit	Condition
Supply Voltage	-0.3	+4.0	V	
Input Voltage	-0.3	$V_{DD}+0.3$	V	
Junction Temp	-	+150	°C	
Storage Temp	-55	+150	°C	
Soldering Temp	-	+260	°C	40sec max.
ESD	-		V	
HBM		4000		
MM		400		
CDM		1500		

Ordering Code



Note: 1000+ years of data retention on internal memory

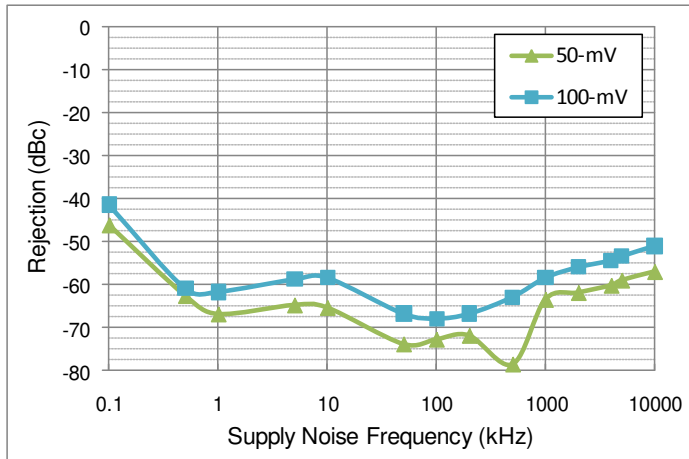
Specifications

Parameter		Condition	Min.	Typ.	Max.	Unit
Supply Voltage ¹	V_{DD}		2.25		3.6	V
Supply Current	I_{DD}	EN pin low – outputs are disabled DSC8103 DSC8123		20	0.095 22	mA
Frequency Stability	Δf	Includes frequency variations due to initial tolerance, temp. and power supply voltage			±10 ±25 ±50	ppm
Aging	Δf	1 year @25°C			±5	ppm
Startup Time ²	t_{SU}	T=25°C			5	ms
Input Logic Levels Input logic high Input logic low	V_{IH} V_{IL}		0.75x V_{DD} -		- 0.25x V_{DD}	V
Output Disable Time ³	t_{DA}				5	ns
Output Enable Time	t_{EN}	DSC8103 DSC8123			5 20	ms ns
Enable Pull-Up Resistor ⁴		Pull-up resistor exist		40		kΩ
LVDS Outputs						
Supply Current	I_{DD}	Output Enabled, $R_L=50\Omega$		29	32	mA
Output offset Voltage	V_{OS}	R=100Ω Differential	1.125		1.4	V
Delta Offset Voltage	ΔV_{OS}				50	mV
Pk to Pk Output Swing	V_{PP}	Single-Ended		350		mV
Output Transition time ³ Rise Time Fall Time	t_R t_F	20% to 80% $R_L=50\Omega$, $C_L=2pF$		200		ps
Frequency	f_0	Single Frequency	10		460	MHz
Output Duty Cycle	SYM	Differential	48		52	%
Period Jitter	J_{PER}			2.5		ps _{RMS}
Integrated Phase Noise	J_{PH}	200kHz to 20MHz @156.25MHz 100kHz to 20MHz @156.25MHz 12kHz to 20MHz @156.25MHz		0.28 0.4 1.7	2	ps _{RMS}

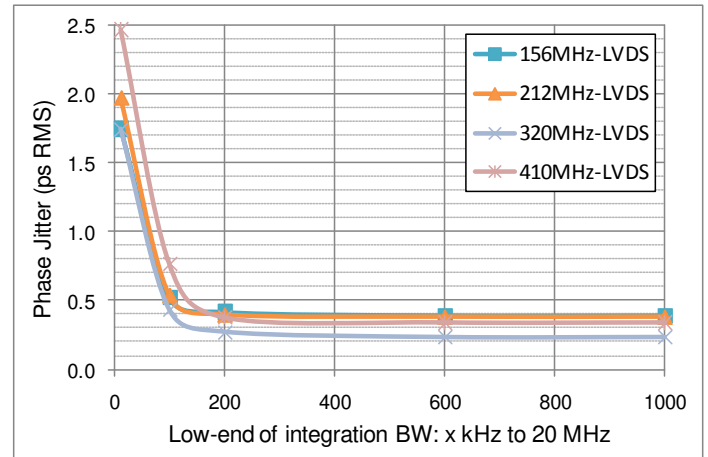
Notes:

- Pin 6 V_{DD} should be filtered with 0.1uF capacitor.
- t_{su} is time to 100ppm of output frequency after V_{DD} is applied and outputs are enabled.
- Output Waveform and Test Circuit figures below define the parameters.
- Output is enabled if pad is floated or not connected.

Nominal Performance Parameters (Unless specified otherwise: $T=25^{\circ}\text{C}$, $V_{DD}=3.3\text{V}$)

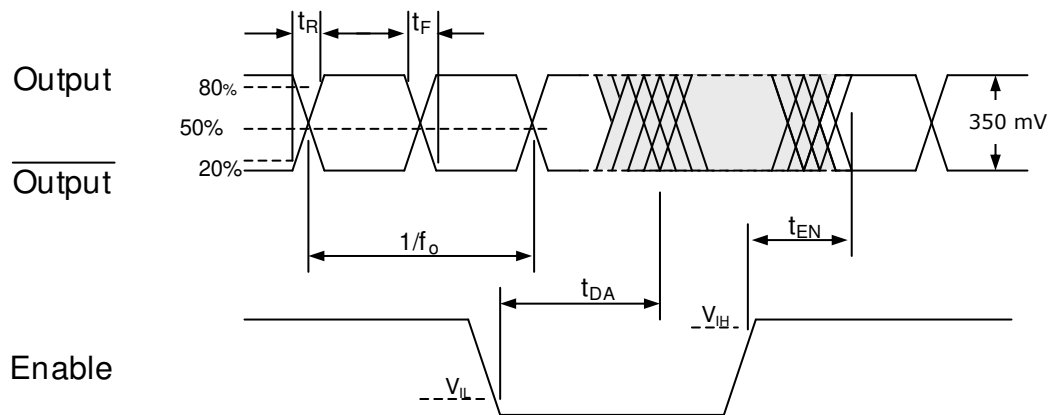


Power supply rejection ratio

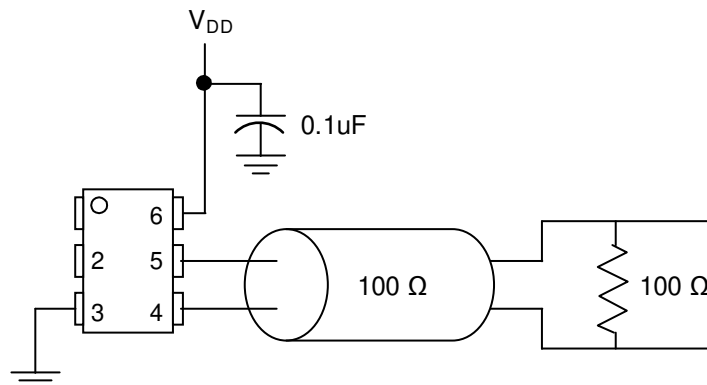


Phase jitter (integrated phase noise)

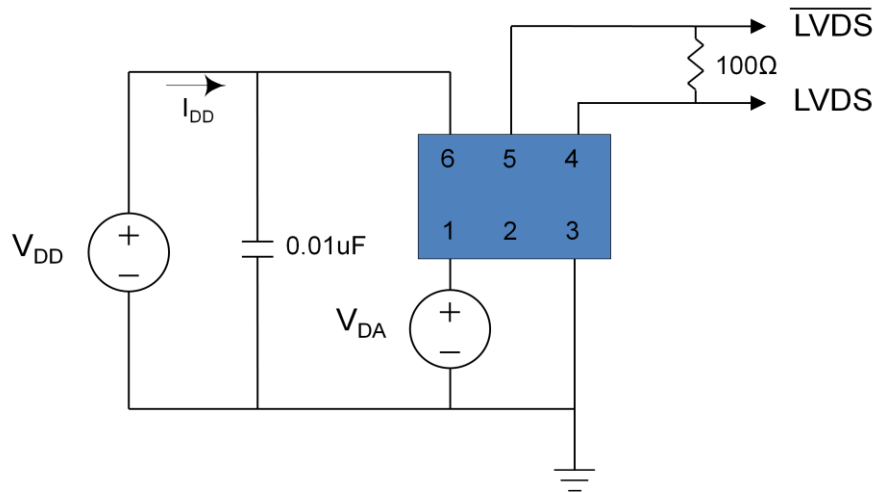
Output Waveform



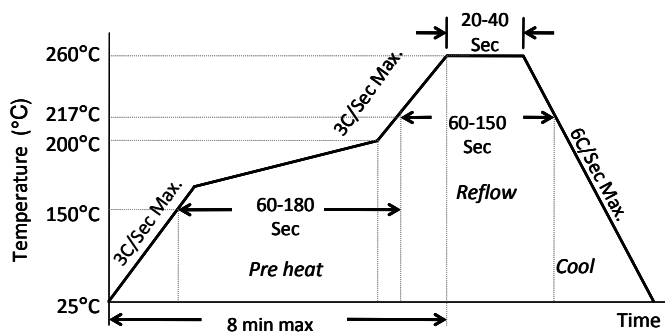
Typical Termination Scheme



Test Circuit



Solder Reflow Profile

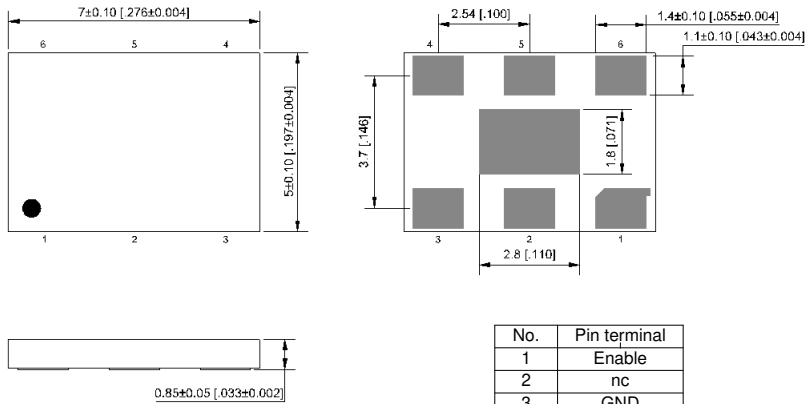


MSL 1 @ 260°C refer to JSTD-020C	
Ramp-Up Rate (200°C to Peak Temp)	3°C/Sec Max.
Preheat Time 150°C to 200°C	60-180 Sec
Time maintained above 217°C	60-150 Sec
Peak Temperature	255-260°C
Time within 5°C of actual Peak	20-40 Sec
Ramp-Down Rate	6°C/Sec Max.
Time 25°C to Peak Temperature	8 min Max.

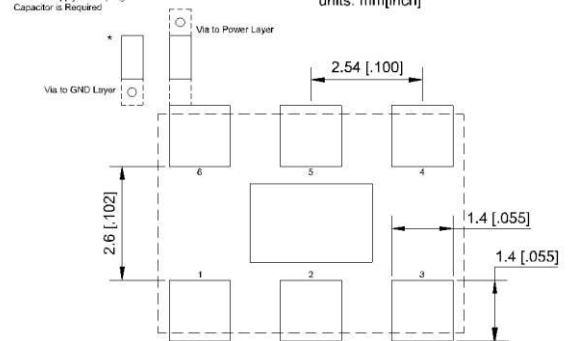
Package Dimensions

7.0 x 5.0 mm Plastic Package

External Dimensions
units: mm[inch]

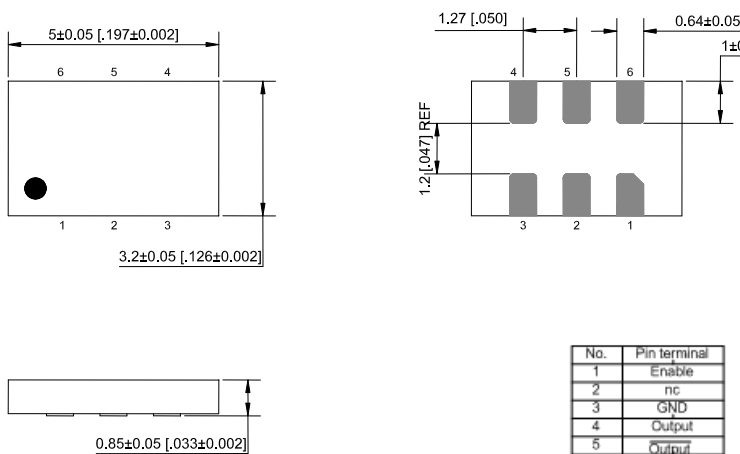


Recommended
Solder Pad Layout
units: mm[inch]

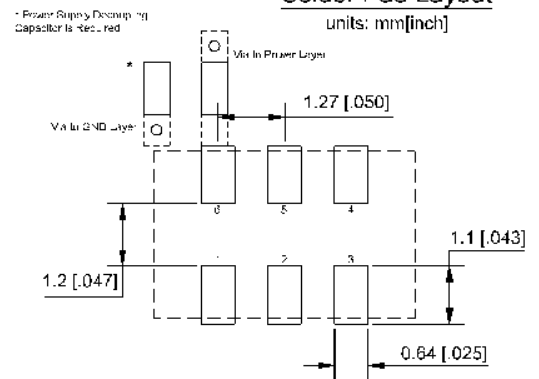


5.0 x 3.2 mm Plastic Package

External Dimensions
units: mm[inch]



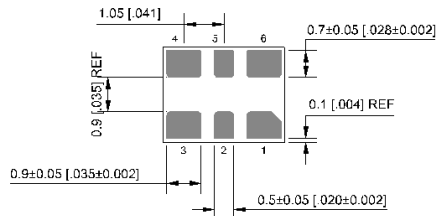
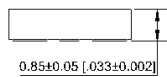
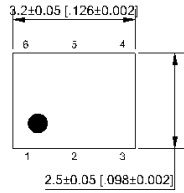
Recommended
Solder Pad Layout
units: mm[inch]



3.2 x 2.5 mm Plastic Package

External Dimensions

units: mm[inch]

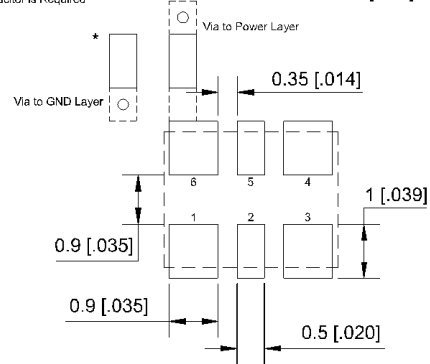


No.	Pin terminal
1	Enable
2	nc
3	GND
4	Output
5	Output
6	VDD

Recommended Solder Pad Layout

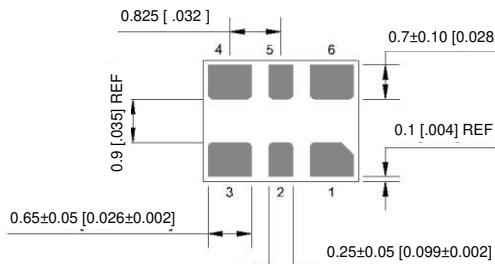
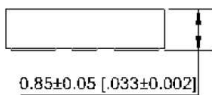
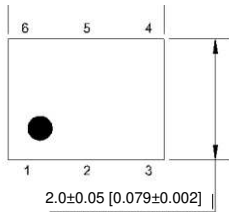
units: mm[inch]

* Power Supply Decoupling Capacitor is Required



2.5 x 2.0 mm Plastic Package

2.5±0.05 [0.098±0.002]

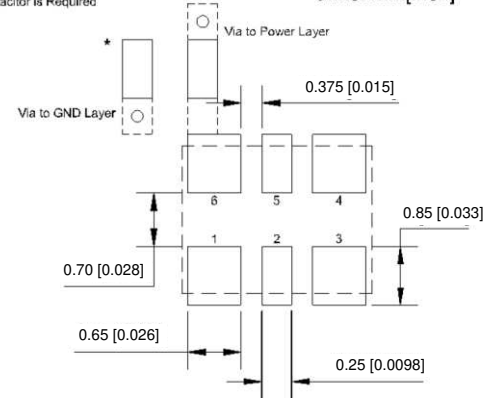


No.	Pin terminal
1	Enable
2	nc
3	GND
4	Output
5	Output
6	VDD

Recommended Solder Pad Layout

units: mm[inch]

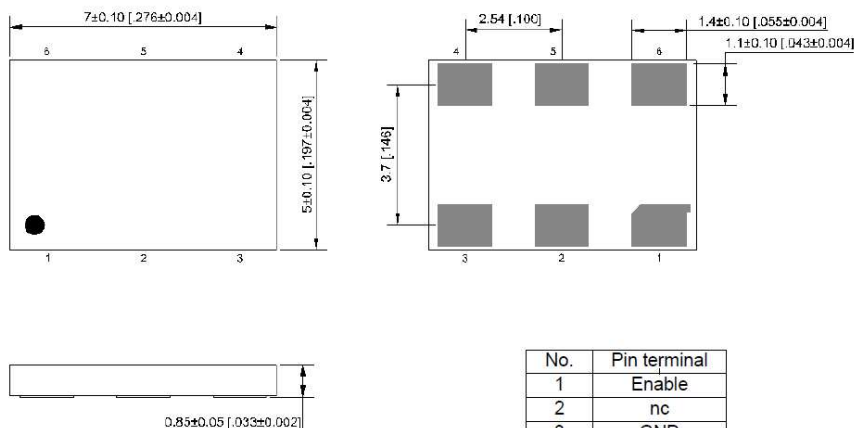
* Power Supply Decoupling Capacitor is Required



7.0 x 5.0 mm Plastic Package

External Dimensions

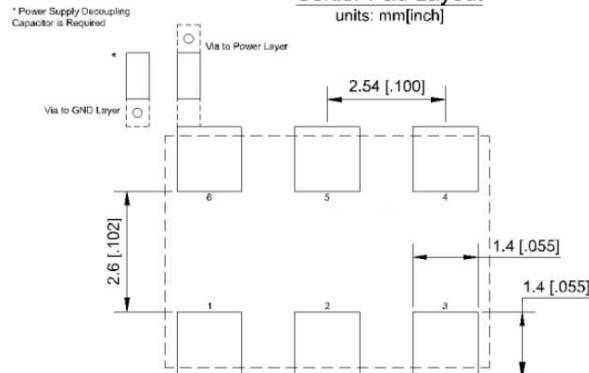
units: mm[inch]



No.	Pin terminal
1	Enable
2	nc
3	GND
4	Output
5	Output
6	VDD

Recommended Solder Pad Layout

units: mm[inch]



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